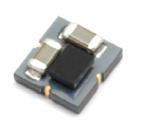


1. Features

- Low EMI noise and small footprint (11mm²)using inductor-imbedded ferrite substrate
- High efficiency using synchronous rectifier technology at 4MHz operation.
- Power-Save mode / Forced PWM automatic mode switching function
- 2% DC output voltage accuracy (PWM mode).
- 1A maximum load capability
- Wide input voltage range : 2.5 5.5V
- Fixed output voltage : 1.0V, 1.2V, 1.5V, 1.8V, 2.5V, 3.3V
- Internal soft start, over current protection, thermal shutdown protection



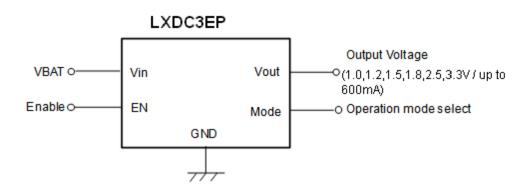
2. Description

The LXDC3EP series is a 1A output step-down DC-DC converter, which is suitable for a space-limited or noise-sensitive application. The device utilizes an inductor-embedded ferrite substrate, and the substrate eliminates radiated EMI noise and conduction noise efficiently.

With just this device, it can be used as a LDO replacement. Its low noise feature assures reliable power supply quality.

The LXDC3EP series has a mode pin that allows the user to select Forced PWM mode or Power-Save mode that changes modes between pulse-skip operation and PWM operation automatically depending on the load. In Power-Save mode, LXDC3EP series offers superior efficiency under light load conditions, and it extends the battery life. When Forced PWM mode is selected, it works at a fixed frequency (4MHz) within the load range. The advantages of this mode are easy filtering of the switching frequency and a better load transient response. The integrated over current protection and the thermal shutdown protection features offer reliable power supply operation.

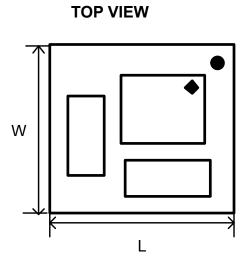
3. Typical Application Circuit

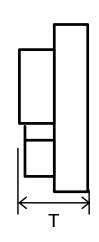




4. Mechanical details

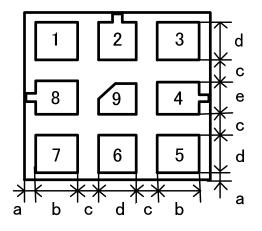
4-1 Out line





SIDE VIEW

BOTTOM VIEW



unit (mm)

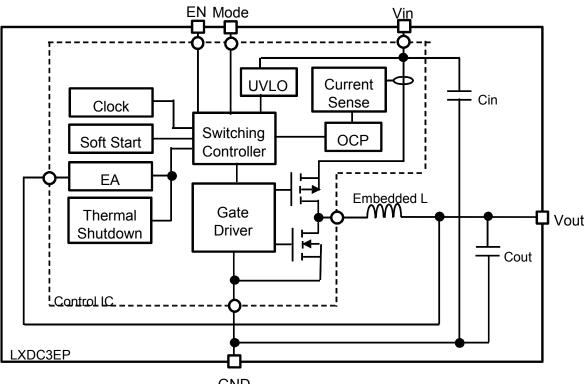
Symbol	Dimension	Symbol	Dimension
L	3.5+/- 0.2	а	0.2+/- 0.2
W	3.2+/- 0.2	b	0.8+/- 0.1
Т	1.3MAX	С	0.4+/- 0.1
		d	0.7+/- 0.1
		е	0.6+/- 0.1



4-2 Pin function

Pin	Symbol	I/O	Function
1	EN	Input	This is the ON/OFF control pin of the device. The device is in shutdown mode when the voltage to this pin is below 0.4V. Pulling this pin above 1.2V turns on the device with a soft start. This pin should not be left floating. EN=H: Device ON, EN=L: Device OFF
2,3,5,6,9	GND		Ground pin
4	Vout	Output	Regulated voltage output pin. Apply output load between this pin and GND.
7	MODE	Input	This is the operation mode select pin. This pin must not be left floating and must be terminated. Mode=H: Forced PWM mode Mode=L: Power-Save mode
8	Vin	Input	The Vin pin supplies current to the LXDC3EP internal regulator.

4-3 Functional Block Diagram



GND



5. Ordering Information

Part number	Output Voltage	Device Specific Feature	MOQ
LXDC3EP10A-176	1.0V	Standard type	T/R,1000pcs/R
LXDC3EP12A-104	1.2V	Standard type	T/R,1000pcs/R
LXDC3EP15A-105	1.5V	Standard type	T/R,1000pcs/R
LXDC3EP18A-106	1.8V	Standard type	T/R,1000pcs/R
LXDC3EP25A-109	2.5V	Standard type	T/R,1000pcs/R
LXDC3EP33A-107	3.3V	Standard type	T/R,1000pcs/R

6. Electrical Specification

6-1 Absolute maximum ratings

Parameter	symbol	rating	Unit
Maximum pin voltage	Vin, EN, MODE	6.0	V
Operating ambient temperature	T _a	-30 to +85	°C
Operating IC temperature	T _{IC}	-30 to +125	°C
Storage temperature	T _{STO}	-30 to +85	°C



6-2 Electrical Characteristics (Ta=25 °C)

Parameter	Symbol	0	Condition	Min.	Тур.	Max.	Unit
		LXDC3EP10A-	176				
		LXDC3EP12A-	104	0.5			
) (in	LXDC3EP15A-105		2.5	3.7	5.5	V
Input voltage	Vin	LXDC3EP18A-106					v
		LXDC3EP25A-109		3.0	3.7	5.5	
		LXDC3EP33A-	107	4.0	5.0	5.5	
UVLO Voltage	UVLO				2.2		V
			LXDC3EP10A-176	0.976	1.0	1.024	
			LXDC3EP12A-104	1.176	1.2	1.224	
Output voltage		PWM Mode	LXDC3EP15A-105	1.47	1.5	1.53	
accuracy	Vout	Vin-Vout>0.7V	LXDC3EP18A-106	1.764	1.8	1.836	V
			LXDC3EP25A-109	2.45	2.5	2.55	
			LXDC3EP33A-107	3.234	3.3	3.366	
Load current range	lout			0	-	1000	mA
	Vrpl	Vin=3.7V Io=1000mA BW=100MHz	LXDC3EP10A-176		15	-	m)/()
			LXDC3EP12A-104				
			LXDC3EP15A-105				
Ripple Voltage			LXDC3EP18A-106				
Ripple Voltage		Vin=3.7V lo=1000mA BW=100MHz	LXDC3EP25A-109	-	20	-	mV(p-p)
		Vin=5.0V lo=1000mA BW=100MHz	LXDC3EP33A-107	-	20	-	
			LXDC3EP10A-176	82	86	-	%
			LXDC3EP12A-104	84	88		
		Vin=3.7V Io=300mA	LXDC3EP15A-105	86	90	-	
Efficiency	EFF		LXDC3EP18A-106	88	92	-	
			LXDC3EP25A-109	90	94	-	
		Vin=5.0V Io=300mA	LXDC3EP33A-107	90	94	-	1
_ ENon		ON; Enable		1.2	-	-	
Enable Voltage	ENoff	OFF; Disable		-	-	0.4	V
MODE Voltage	MODE-H	High; Forced P	WM mode	1.2	-	-	V
	MODE-L	Low; Power-Sa	ve mode	-	-	0.4	v

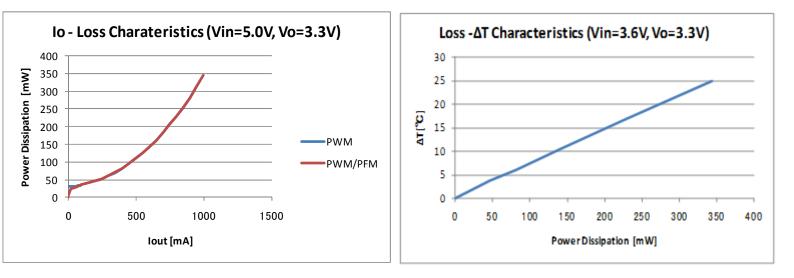


Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
SW Frequency	Freq		-	4	-	MHz
Over Current Protection	OCP		1000	1200	1700	mA
Start -up Time	Ton		-	170	-	usec

(*1)The above characteristics are tested using the application circuit in section 8

6-3 Thermal and Current De-rating Information

The following figure shows an example of the power dissipation and temperature rise characteristics. These data are measured on Murata's evaluation board of this device at a no air-flow condition.

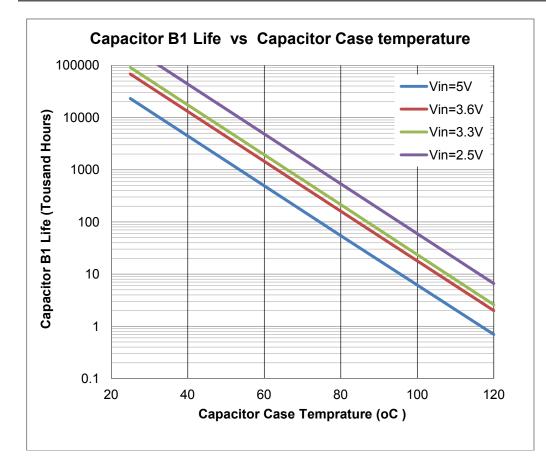


The output current of the device may need to be de-rated if it is operated in high ambient temperature or in an application that requires continuous power delivery. The amount of current de-rating is highly dependent on the environmental thermal conditions, e.g., PCB design, nearby components, or effective air flow. Care should especially be taken in applications where the device temperature exceeds 85°C.

The case temperature of the device must be kept lower than the maximum rating of $125 \,^{\circ}$ C. It is generally recommended to take an appropriate de-rating of the IC temperature for reliable operation. A general de-rating for the temperature of the semiconductor is 80%.

MLCC capacitors' reliability and lifetime are also dependent on temperature and applied voltage stress. Higher temperature and/or higher voltage cause shorter lifetime of the MLCC, and the degradation can be described by the Arrhenius model. The most critical parameter of the degradation is IR (Insulation Resistance). The below figure shows MLCC's B1 life based on a failure rate reaching 1%. It should be noted that wear-out mechanisms in the MLCC capacitor is not reversible but cumulative over time.





The following steps should be taken before the designing for reliable operation.

- 1. The ambient temperature of the device should be kept below $85 \,^{\circ}C$
- 2. The case temperature should be measured on the worst condition of each application. The temperature must be kept below 125 °C. An appropriate de-rating of temperature and/or output current should be taken.
- 3. The MLCC temperature should be considered as same as the case temperature. Considering the above figure, it should be checked if the expected B1 life of MLCC is acceptable or not.

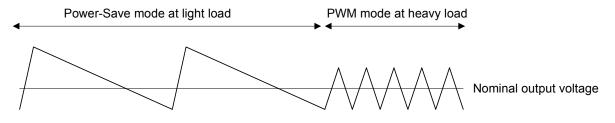


7. Detailed Description

Power-Save Mode / Forced PWM Mode

The MODE pin allows selecting the operating mode. If the MODE pin is pulled to logic low voltage (MODE-L), the converter operates automatic pulse-skip and PWM mode. In this mode, the converter operates pulse-skip mode at light load current, and when the load current increases, the operating mode will changes to PWM mode automatically. In this mode, the converter can work in high efficiency over wide load current range. The transition current between PFM and PWM is depend on Vin, Vout and other factors, but the ballpark threshold is about 50-200mA

If the MODE pin is pulled to logic high voltage (MODE-H), the device operates in Forced PWM mode. In this mode, the converter operates in PWM mode even at light load current. The advantage of this mode is that the converter operates with a fixed frequency that allows simple filtering of switching frequency. In this mode, the efficiency is lower compared to the PFM mode at light load current.



UVLO (Under Voltage Lock Out)

The input voltage (Vin) must reach or exceed the UVLO voltage (2.2Vtyp) before the device begins the start up sequence even when EN pin is kept high. UVLO function keeps away of an unstable operation at low Vin range

Soft Start

The device has an internal soft-start function that limits the inrush current during start-up. The soft-start system progressively increases the switching on-time from a minimum pulse-width to that of normal operation. Because of the function, the output voltage increases gradually from zero to nominal voltage at start-up event. The nominal soft-start time is 170usec.

Enable

The device starts operation when EN is set high and starts up with a soft start. For proper operation, the EN pin must be terminated to logic high and must not be left floating. Pulling the EN pin to logic low forces the device to shutdown.

Over Current Protection

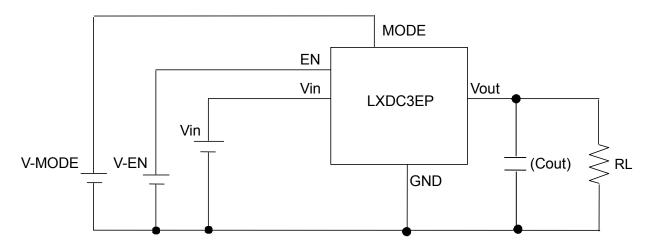
When the output current reaches the OCP threshold, the device narrows the switching duty and decrease the output voltage. When the current goes below the threshold, the converter returns to normal operation automatically.

Thermal Shutdown

The device has a thermal overload protection function. When the internal IC's junction temperature exceeds around 150°C, the device goes into thermal shutdown. The device returns to its normal operation when the Internal IC's junction temperature falls below 130 °C (typ). For reliable operation, the IC temperature should be kept below 125 °C. Prolonged thermal overload condition may damage the device

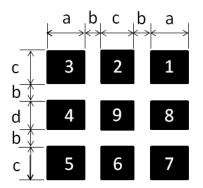


8. Test Circuit



*Optional : Cout: 4.7uF/6.3V (LXDC3EP33A-107)

9. Reference Land Pattern



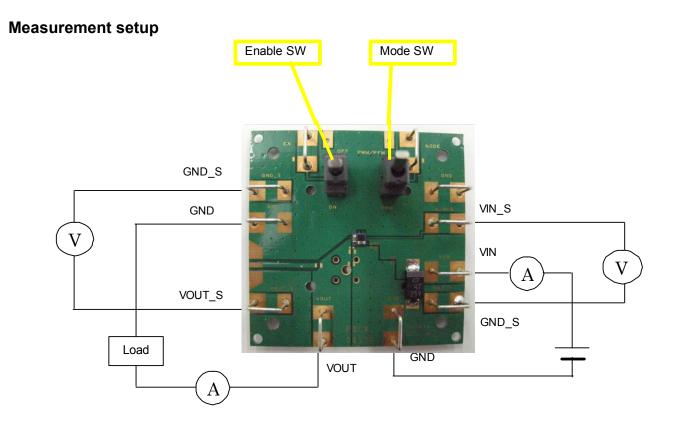
unit (mm)

Symbol	Dimension	Symbol	Dimension
а	0.8	С	0.7
b	0.4	d	0.6



10. Measurement Data

Micro DC-DC Converter evaluation board (P2LX0457B)



The enable switch has three positions.

- 1. When it is toggled "ON", the device starts operation.
- 2. When it is toggled "OFF", the device stops operation and shuts down.
- 3. When it is set to the middle of "ON" and "OFF", the EN pin becomes floating and can have an external voltage applied through the EN terminal pin on the EVB. If you don't apply an external voltage to the EN pin, the enable switch should not to be set to the middle position.

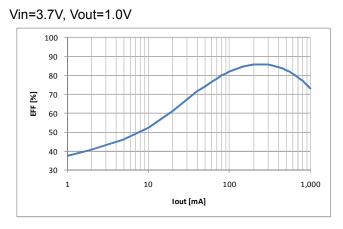
The mode switch has three states (PWM, PFM/PWM and Open).

- 1. When it is shorted to "PWM" side, the device operates PWM forced mode.
- 2. When it is shorted to "PFM/PWM" side, the device operates PFM/PWM automatic mode.
- 3. When it is set to open, the mode pin becomes floated and can be applied an external voltage through the Mode terminal pin on the EVB. If you don't apply external voltage to Mode pin, the mode switch should not to be set to the middle position.

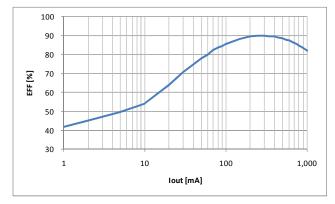


Typical Measurement Data (reference purpose only) (Ta=25°C)

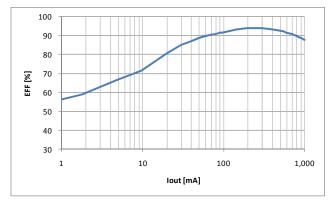
Efficiency

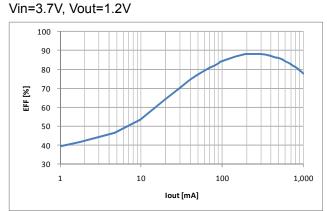


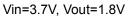
Vin=3.7V, Vout=1.5V

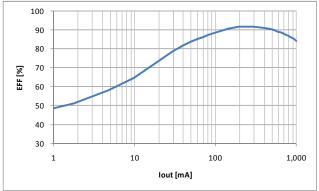


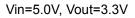
Vin=3.7V, Vout=2.5V

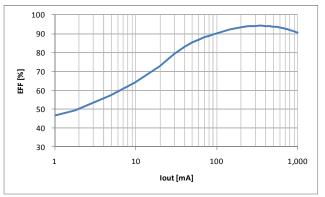






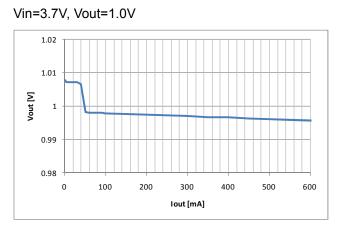


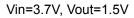


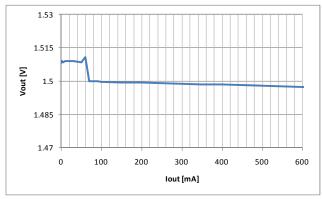




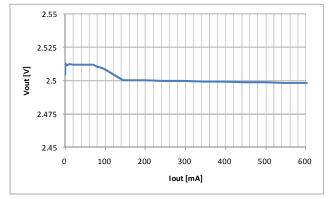
Road Regulation



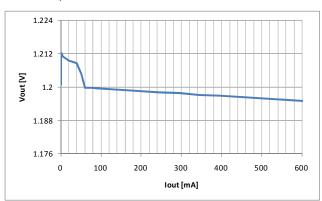


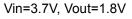


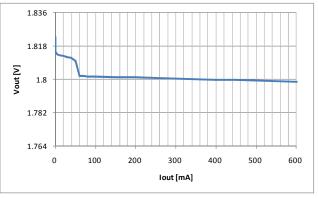
Vin=3.7V, Vout=2.5V

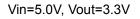


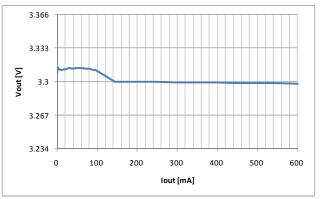
Vin=3.7V, Vout=1.2V





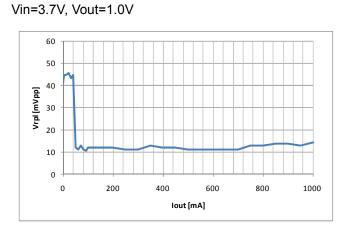




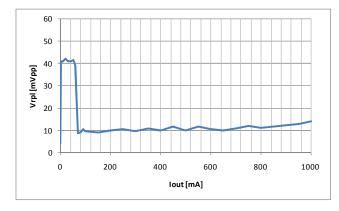




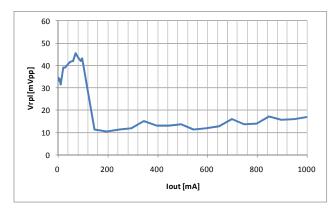
Output Ripple-Noise



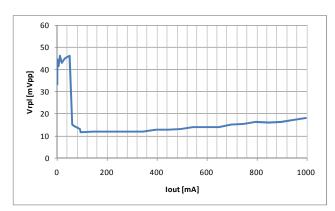
Vin=3.7V, Vout=1.5V

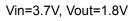


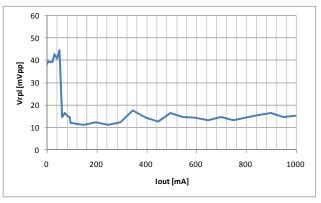
Vin=3.7V, Vout=2.5V

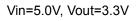


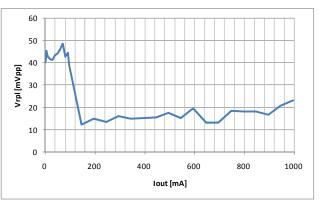
Vin=3.7V, Vout=1.2V









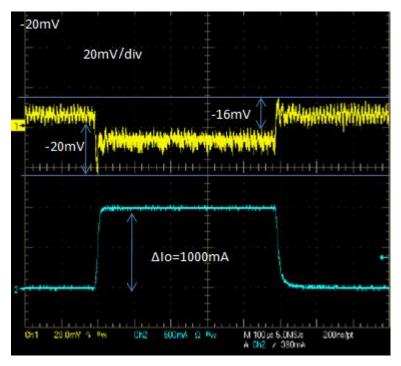




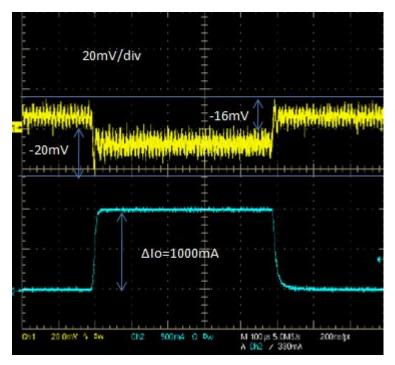
Typical Measurement Data (reference purpose only)

Load Transient Response

Vin=2.3V,Vout=1.2V

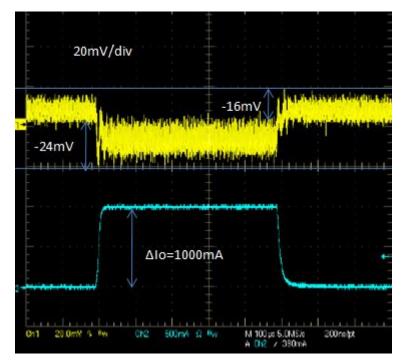


Vin=3.7V,Vout=1.2V

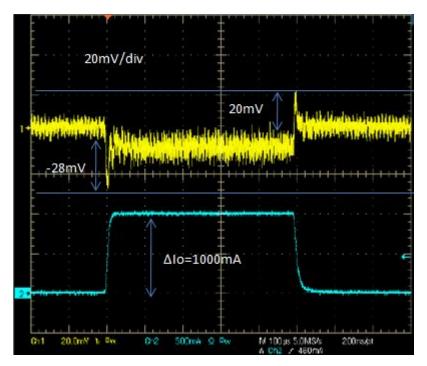




Vin=5.5V,Vout=1.2V

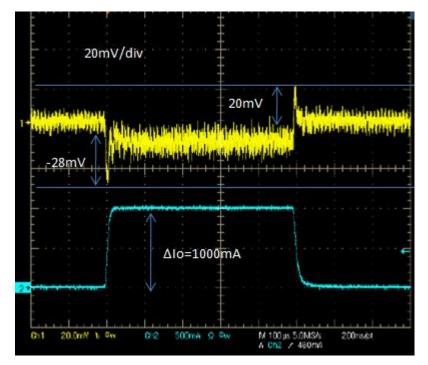


Vin=5.0V,Vout=3.3V





Vin=5.5V,Vout=3.3V





11.Reliability Tests

No.	Items	Condition	Number	Result (Fail)
1	Vibration Resistance	Frequency : 10~2000 Hz Acceleration : 196 m/s2 Direction : X,Y,Z 3 axis Period : 2.5h on each	18	G (0)
2	Shock	Acceleration : 980m/s2 Period : 6 ms. Cycle : 6direction x 3 times	18	G (0)
3	Deflection	Solder specimens on the testing jig (glass epoxy boards) are shown in the figure. No damage with 1.6mm deflection Specimen 45mm 45mm Solder specimen 1.6mm 1.6mm	18	G (0)
4	Soldering strength (Push Strength)	Solder specimens on the test jig shown below. Apply pushing force at 10N and increase the force until the electrode pads are peeled off or the ceramics are broken. The pushing force is applied in the longitudinal direction. Pushing Direction Specimen	18	G (0)
5	Solderability of Termination	75% of the terminations are to be soldered evenly and continuously.	18	G (0)
6	Heat Shock	Temperature: -30°C 30min , 85°C 30min Period :30min on each Cycle :100 times	18	G (0)
7	High Temp Exposure	Temperature:85°C Period :1000h	18	G (0)
8	Low Temp Exposure	Temperature:-30°C Period :1000h	18	G (0)
9	Humidity(Steady State)	Temperature:85°C Humidity:85%RH Period :1000h	18	G (0)

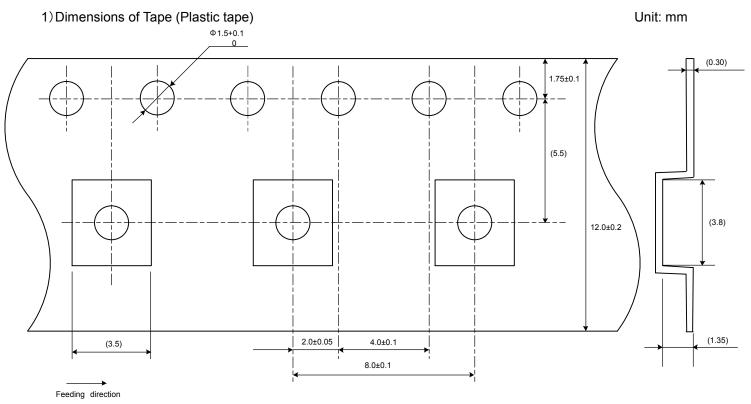


No	Items	Condition	Number	Result (Fail)
10	ESD(Machine Model)	C:200pF、R:0Ω TEST Voltage :+/-200V	18	G (0)
11	ESD(Human Body Model)	C:100pF、R:1500Ω TEST Voltage :+/-2000V	18	G (0)
12	ESD(Charged Machine Model)	Confirming to JEITA4701 300-2 TEST Voltage :+/-500V	18	G (0)



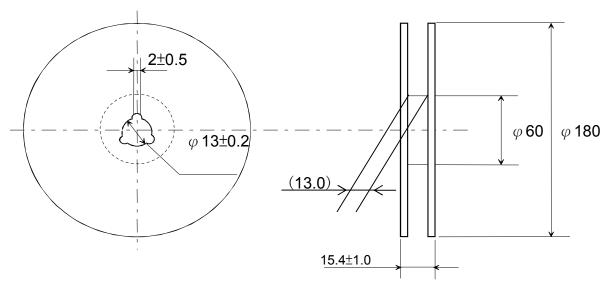
LXDC3EP series Micro DC-DC converter

12. Tape and Reel Packing



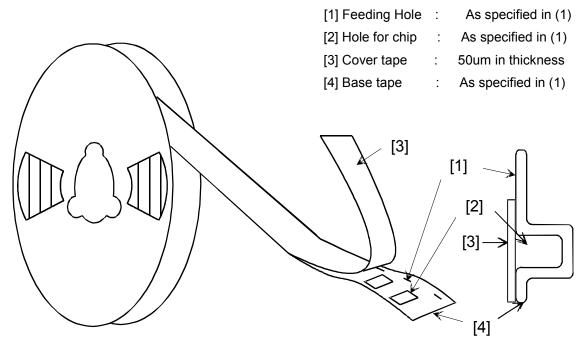
2) Dimensions of Reel

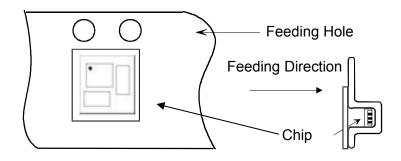
Unit: mm





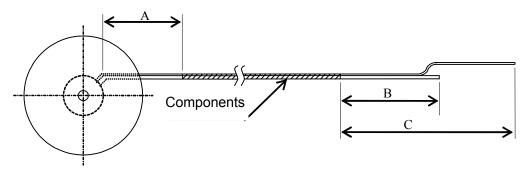
3) Taping Diagrams





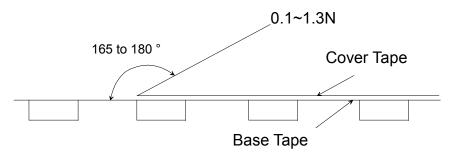


4) Leader and Tail tape



Symbol	Items	Ratings(mm)
А	No components at trailer	min 160
В	No components at leader	min 100
С	Whole leader	min 400

- 5) The tape for modules is wound clockwise with the feeding holes to the right side as the tape is pulled towards the user.
- 6) Packaging unit: 1,000 pcs./ reel
- 7) Material: Base Tape ... Plastic
 Reel ... Plastic
 Antistatic coating for both base tape and reel
- 8) Peeling of force





NOTICE

1. Storage Conditions:

To avoid damaging the solderability of the external electrodes, be sure to observe the following points.

- Store products where the ambient temperature is 15 to 35 °C and humidity 45 to 75% RH.
- (Packing materials, In particular, may be deformed at the temperature over 40 °C.).
- Store products in non corrosive gas (Cl₂, NH₃,SO₂, No_x, etc.).
- Stored products should be used within 6 months of receipt. Solderability should be verified if this period is exceeded

This product is applicable to MSL1 (Based on IPC/JEDEC J-STD-020)

2. Handling Conditions:

Be careful in handling or transporting the product. Excessive stress or mechanical shock may damage the product because of the nature of ceramics structure.

Do not touch the product, especially the terminals, with bare hands. Doing so may result in poor solderability.

3. Standard PCB Design (Land Pattern and Dimensions):

All the ground terminals should be connected to ground patterns. Furthermore, the ground pattern should be provided between the IN and OUT terminals. Please refer to the specifications for the standard land dimensions.

The recommended land pattern and dimensions are shown for a reference purpose only. Electrical, mechanical and thermal characteristics of the product depend on the pattern design and material / thickness of the PCB. Therefore, be sure to check the product performance in the actual set. When using underfill materials, be sure to check the mechanical characteristics in the actual set.

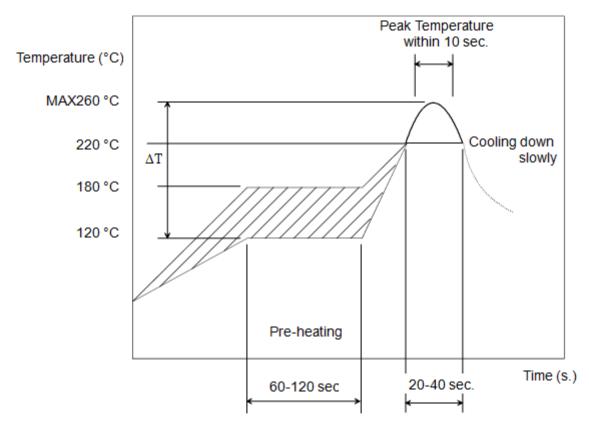


4. Soldering Conditions:

Soldering is allowed up through 2 times.

Carefully perform preheating $: \triangle T$ less than 130 °C.

When products are immersed in solvent after mounting, pay special attention to maintain the temperature difference within 100 °C. Soldering must be carried out by the above mentioned conditions to prevent products from damage. Contact Murata before use if concerning other soldering conditions.



Reflow soldering standard conditions (example)

Use rosin type flux or weakly active flux with a chlorine content of 0.2 wt % or less.



5. Cleaning Conditions:

The product is not designed to be cleaned after soldering.

6. Operational Environment Conditions:

Products are designed to work for electronic products under normal environmental conditions (ambient temperature, humidity and pressure). Therefore, products have no problems to be used under the similar conditions to the above-mentioned. However, if products are used under the following circumstances, it may damage products and leakage of electricity and abnormal temperature may occur.

- In an atmosphere containing corrosive gas (Cl₂, NH₃, SO_x, NO_x etc.).
- In an atmosphere containing combustible and volatile gases.
- In a dusty environment.
- Direct sunlight
- Water splashing place.
- Humid place where water condenses.
- In a freezing environment.

If there are possibilities for products to be used under the preceding clause, consult with Murata before actual use.

If static electricity is added to this product, degradation and destruction may be produced.

Please use it after consideration enough so that neither static electricity nor excess voltage is added at the time of an assembly and measurement.

If product malfunctions may result in serious damage, including that to human life, sufficient fail-safe measures must be taken, including the following:

- (1) Installation of protection circuits or other protective device to improve system safety
- (2) Installation of redundant circuits in the case of single-circuit failure

7. Input Power Capacity:

Products shall be used in the input power capacity as specified in this specifications.

Inform Murata beforehand, in case that the components are used beyond such input power capacity range .



8. Limitation of Applications:

The products are designed and produced for application in ordinary electronic equipment (AV equipment, OA equipment, telecommunication, etc). If the products are to be used in devices requiring extremely high reliability following the application listed below, you should consult with the Murata staff in advance.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment.
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-procession equipment.
- Application which malfunction or operational error may endanger human life and property of assets.
- Application which related to occurrence the serious damage
- Application of similar complexity and/ or reliability requirements to the applications listed in the above



Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.

Product specifications are subject to change or our products in it may be discontinued without advance notice.

This catalog is for reference only and not an official product specification document, therefore, please review and approve our official product specification before ordering this product.

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